Process / Product Change Notification



N° 1009-DISTI42-C4048408-Private

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Decommission of Newport, Wales wafer fab, as announced on May 5th 2015

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 07-September-2017.
- Infineon aligns with the widely-recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgment of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
Postal Address Headquarters: Am Campeon 1-12, D-85579 Neubiberg, Phone +49 (0)89 234-0
Chairman of the Supervisory Board: Wolfgang Mayrhuber
Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck
Registered Office: Neubiberg Commercial Register
Amtsgericht München HRB 126492

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► Products affected:

Sales Name	SP N°	OPN	Package
IRLHS6242TRPBF	SP001573008	IRLHS6242TRPBF	PQFN 2X2 6L
IRLHS6276TRPBF	SP001552670	IRLHS6276TRPBF	PG-TSDSON-6-900
IRLHS6342TRPBF	SP001573840	IRLHS6342TRPBF	PQFN 2X2 6L
IRLHS6376TRPBF	SP001573000	IRLHS6376TRPBF	PG-TSDSON-6-900
IRLML6244TRPBF	SP001558344	IRLML6244TRPBF	SOT23
IRLML6346TRPBF	SP001578770	IRLML6346TRPBF	SOT23
IRLR6225TRPBF	SP001573984	IRLR6225TRPBF	DPAK

▶ Detailed Change Information:

Subject: Add Vanguard as qualified wafer fab and Etrend as qualified wafer test site for Mosfet Gen

12.2

Reason: As part of a manufacturing consolidation plan announced in March 2015, Infineon indicated

that it would be closing the Fab facility and transferring the production capability for certain parts to Silicon Foundry. For the avoidance of doubt, in order to retain necessary flexibility to ensure supply security, the supply of products during the transition period will include products

from both the old and the new site(s).

Description: Decommission of Newport, Wales wafer fab, as announced on May 5th 2015

MOSFET Gen 12.2

	OLD	NEW	
Wafer Fab Location	Infineon Technologies Newport Limited	Vanguard International Semiconductor	
Wafer Test Location	Infineon Technologies Newport Limited	ETREND Hightech Corp, Hsin-Chu, TW	

► Product Identification:

Wafer fab origins will not be distinguished through the external part marking or shipping labels, however, based on the assembly lot code and marked on the device. IFX internal systems will be able to trace the site of the wafer lots used to produce the final product.

► Impact of Change:

No changes to form, fit, or function. The package outline remains the same. Datasheet specifications will not be changed. The package bill of material and the location for assembly and final test will not change.

► Attachments:

► Time Schedule:

Final qualification report:

Available

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First samples available:
On request

Intended start of delivery:
19-September-2017

If you have any questions, please do not hesitate to contact your local Sales office.

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